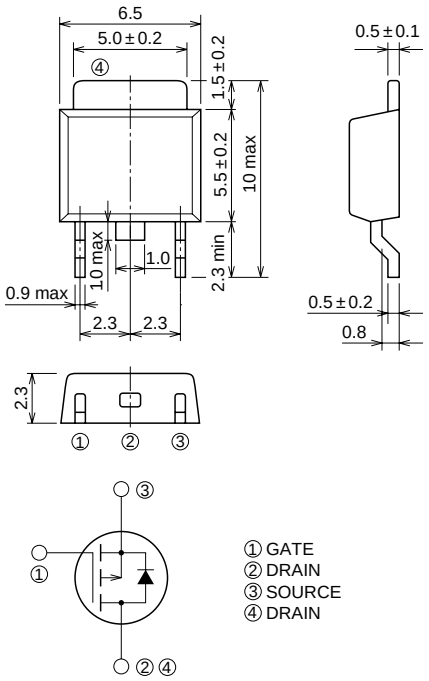
FX3ASJ-3

HIGH-SPEED SWITCHING USE

FX3ASJ-3

- 4V DRIVE
- V_{DSS} ..... –150V
- $r_{DS\ (ON)\ (MAX)}$ 1.2Ω
- I_D ..... –3A
- Integrated Fast Recovery Diode (TYP.) 80ns

OUTLINE DRAWING Dimensions in mm



MP-3

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (T_C = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V_{DSS}	Drain-source voltage	V_{GS} = 0V	–150	V
V_{GSS}	Gate-source voltage	V_{DS} = 0V	±20	V
I_D	Drain current		–3	A
I_{DM}	Drain current (Pulsed)		–12	A
I_{DA}	Avalanche drain current (Pulsed)	L = 100µH	–3	A
I_S	Source current		–3	A
I_{SM}	Source current (Pulsed)		–12	A
P_D	Maximum power dissipation		30	W
T_{ch}	Channel temperature		–55 ~ +150	°C
T_{stg}	Storage temperature		–55 ~ +150	°C
—	Weight	Typical value	0.26	g

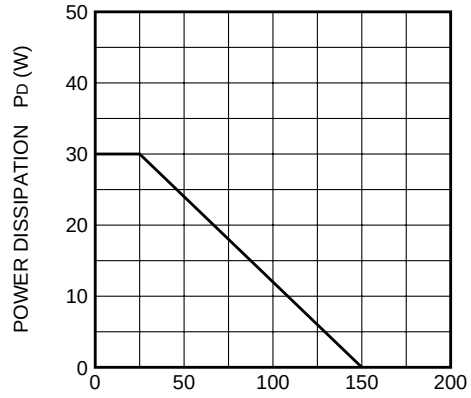
MITSUBISHI ELECTRIC

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

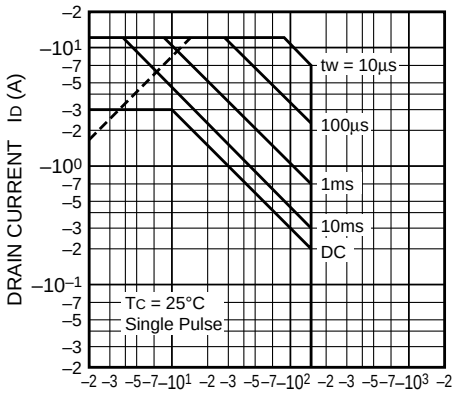
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
$V_{(BR)DSS}$	Drain-source breakdown voltage	I_D = –1mA, V_{GS} = 0V	–150	—	—	V
I_{GSS}	Gate-source leakage current	V_{GS} = ±20V, V_{DS} = 0V	—	—	±0.1	µA
I_{DSS}	Drain-source leakage current	V_{DS} = –150V, V_{GS} = 0V	—	—	–0.1	mA
$V_{GS(th)}$	Gate-source threshold voltage	I_D = –1mA, V_{DS} = –10V	–1.0	–1.5	–2.0	V
$r_{DS(ON)}$	Drain-source on-state resistance	I_D = –1A, V_{GS} = –10V	—	0.93	1.20	Ω
$r_{DS(ON)}$	Drain-source on-state resistance	I_D = –1A, V_{GS} = –4V	—	1.02	1.32	Ω
$V_{DS(ON)}$	Drain-source on-state voltage	I_D = –1A, V_{GS} = –10V	—	–0.93	–1.20	V
$\|y_{fs}\|$	Forward transfer admittance	I_D = –1A, V_{DS} = –5V	—	3.0	—	S
C_{iss}	Input capacitance	V_{DS} = –10V, V_{GS} = 0V, f = 1MHz	—	1170	—	pF
C_{oss}	Output capacitance		—	81	—	pF
C_{rss}	Reverse transfer capacitance		—	31	—	pF
$t_{d(on)}$	Turn-on delay time	V_{DD} = –80V, I_D = –1A, V_{GS} = –10V, R_{GEN} = R_{GS} = 50Ω	—	9	—	ns
t_r	Rise time		—	7	—	ns
$t_{d(off)}$	Turn-off delay time		—	82	—	ns
t_f	Fall time		—	33	—	ns
V_{SD}	Source-drain voltage	I_S = –1A, V_{GS} = 0V	—	–1.0	–1.5	V
$R_{th(ch-c)}$	Thermal resistance	Channel to case	—	—	4.17	°C/W
t_{rr}	Reverse recovery time	I_S = –3A, dis/dt = 100A/µs	—	80	—	ns

PERFORMANCE CURVES

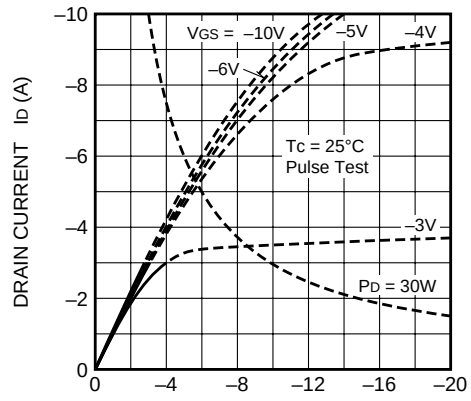
POWER DISSIPATION DERATING CURVE



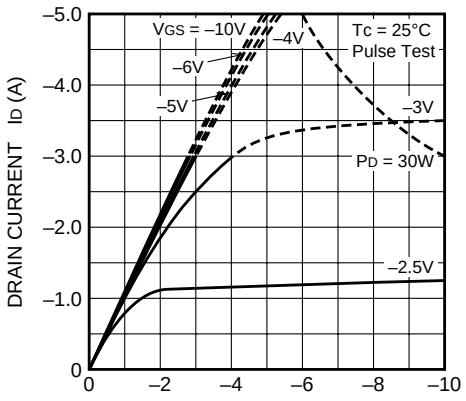
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)

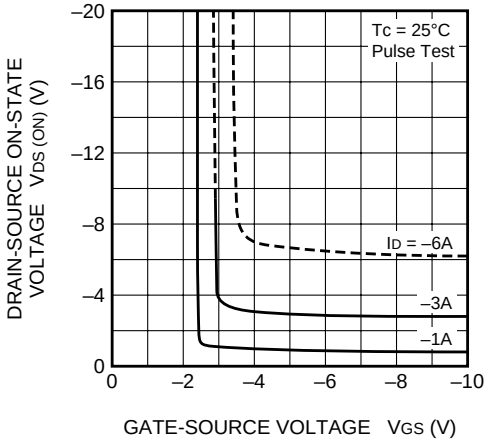


OUTPUT CHARACTERISTICS (TYPICAL)

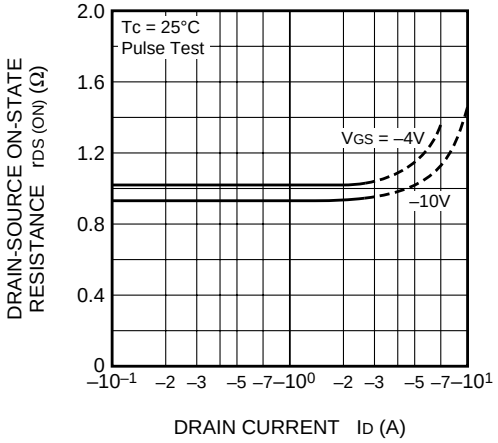


MITSUBISHI ELECTRIC

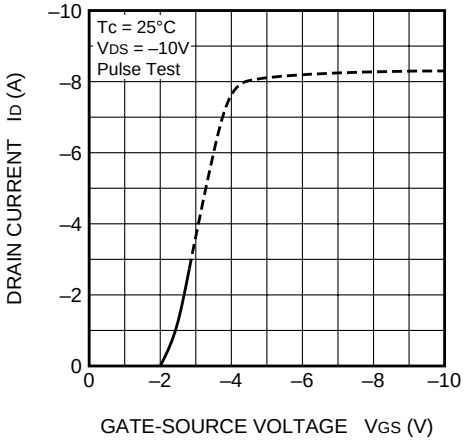
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



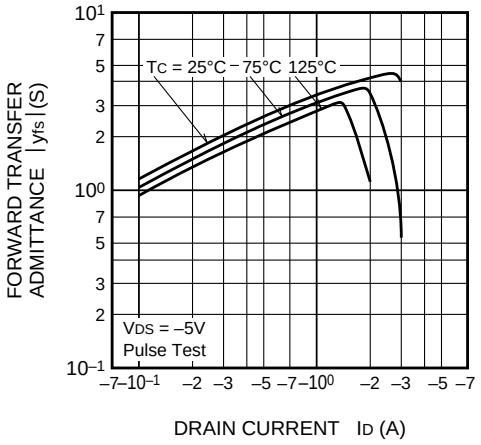
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



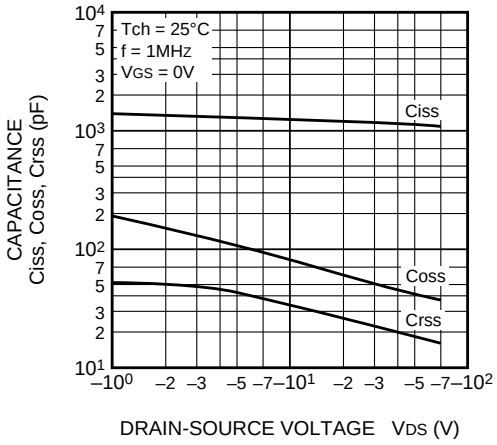
TRANSFER CHARACTERISTICS (TYPICAL)



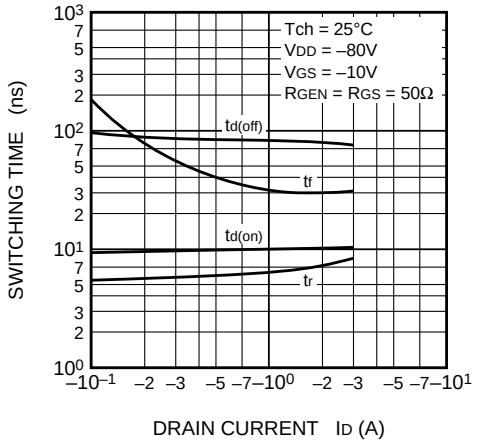
FORWARD TRANSFER ADMITTANCE VS.DRAIN CURRENT (TYPICAL)



CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



SWITCHING CHARACTERISTICS (TYPICAL)



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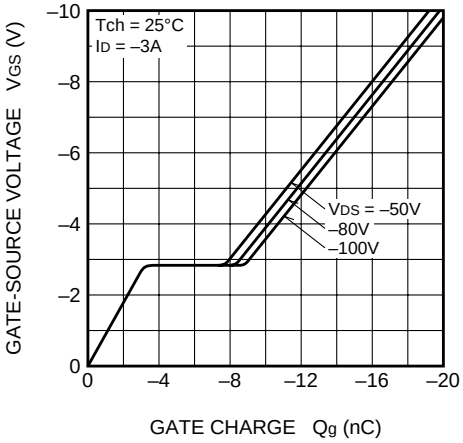
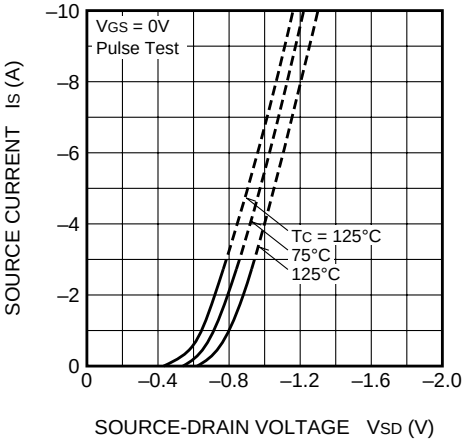
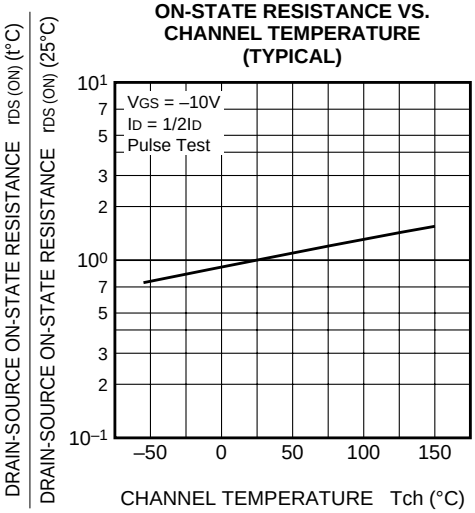
GATE-SOURCE VOLTAGE VS.GATE CHARGE (TYPICAL)



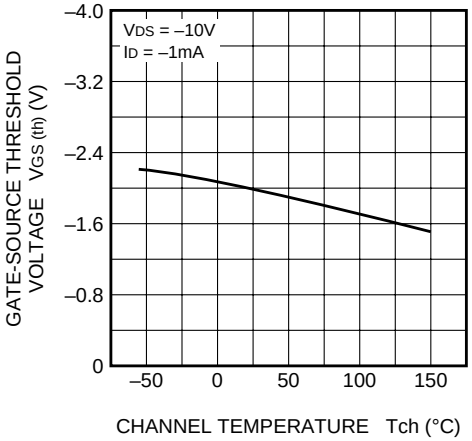
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



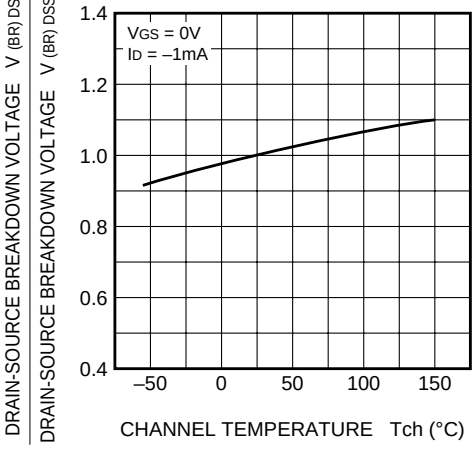
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS